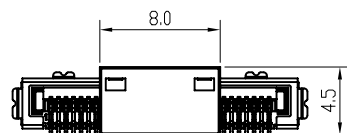
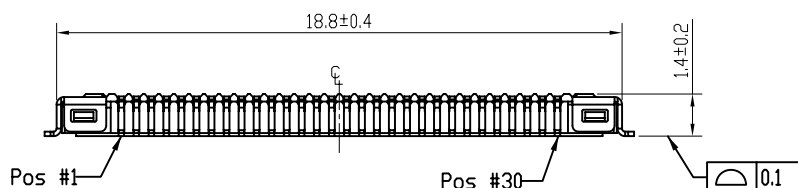
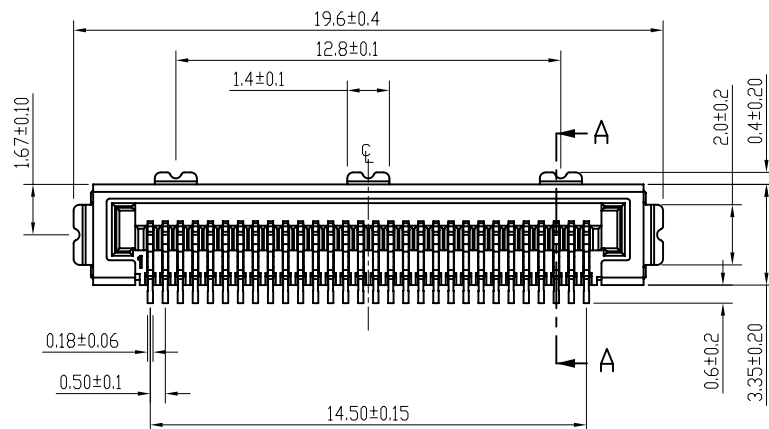
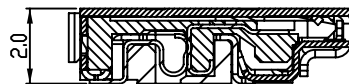
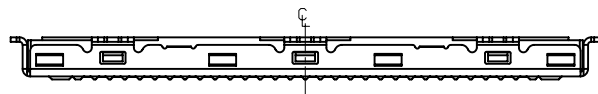
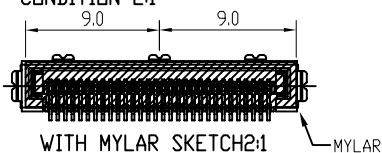




A B C D E F

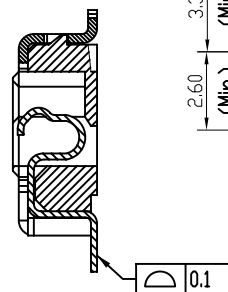


VACUUM CLIP INSTALLATION
CONDITION 2:1



WITH MYLAR SKETCH 2:1

MYLAR



Section A-A
Scale 8:1

NOTES:

1. MATERIAL:

- 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.
- 1.2 CONTACT: COPPER ALLOY
- 1.3 SHELL: COPPER ALLOY

2. FINISH:

2.1 CONTACT:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE

2.2 SHELL:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXX

4. PACKAGE PLS. REFER TO 50406-XXXX-TRP/50406-XXXX-00-TRP 50406-XXXX-02-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

50406-XXX X X-XXX

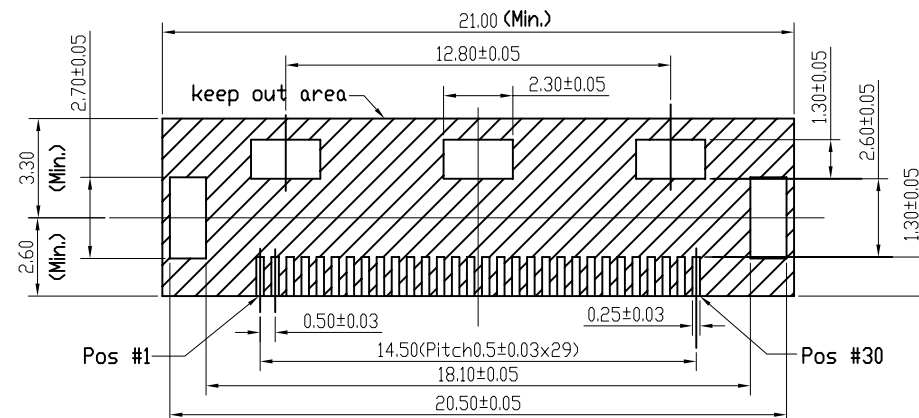
PACKING	
001	50406-XXXX-00(WITH MYLAR)
W01	50406-XXXX-02(WITH COVER)
	50406-XXXX-02

PACKING

- 1.TUBE
- 7.TAPE REEL WITH COVER
- 4.TAPE REEL WITH MYLAR

CONTACT PLATING

- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE



一般公差
TOLERANCES
X ±0.5 XX ±0.15
X ±0.25 XXX ±0.1
ANGLES ±2°

檢驗尺寸標示
SYMBOLS ① ② INDICATE
CLASSIFICATION DIMENSION

① MARK IS CRITICAL DIM.

② MARK IS MAJOR DIM.

表面處理 (FINISH)

宏致電子股份有限公司
Aces Electronics Co.,Ltd.

品名 (TITLE)
0.5mm LVDS CONN.

圖號 (DWG NO.)
50406-XXXX-XXX

比例 (SCALE)
4:1

單位 (UNITS)
mm

製圖 (DR)
14/09/22 XIUJIN

審核 (CHKD)
BRAVE

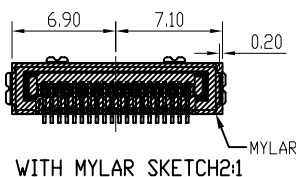
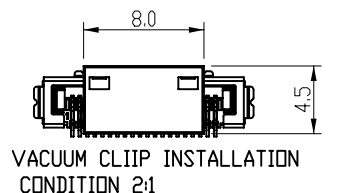
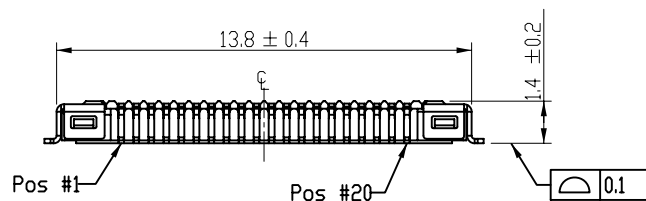
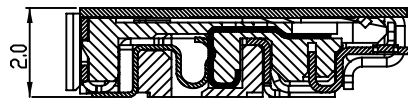
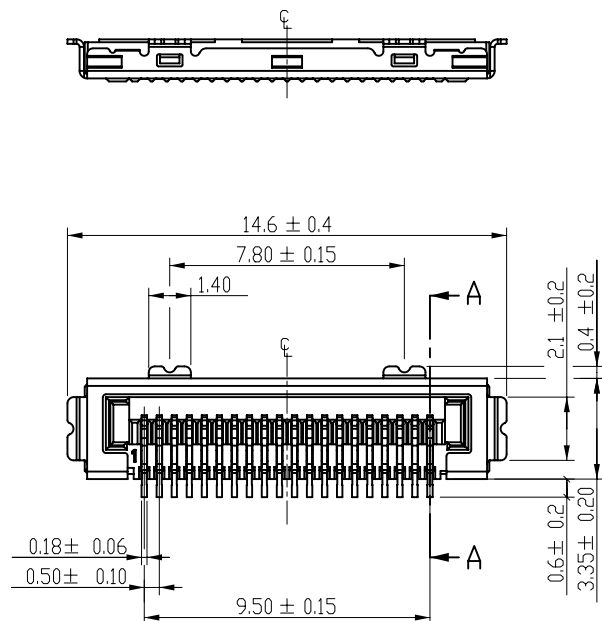
核准 (APPD)
FRANK

張數 (SHEET)
1 OF 3

SIZE
A4

REV
J

A B C D E F



Section A-A
Scale 8:1

NOTES:

1. MATERIAL:

- 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.
- 1.2 CONTACT: COPPER ALLOY
- 1.3 SHELL: COPPER ALLOY

2. FINISH:

2.1 CONTACT:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE

2.2 SHELL:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXX

- 4. PACKAGE PLS. REFER TO 50406-XXXX-TRP/50406-XXXX-02-TRP
50406-XXXX-04-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

50406-XXX X X-XXX

020.20Pin

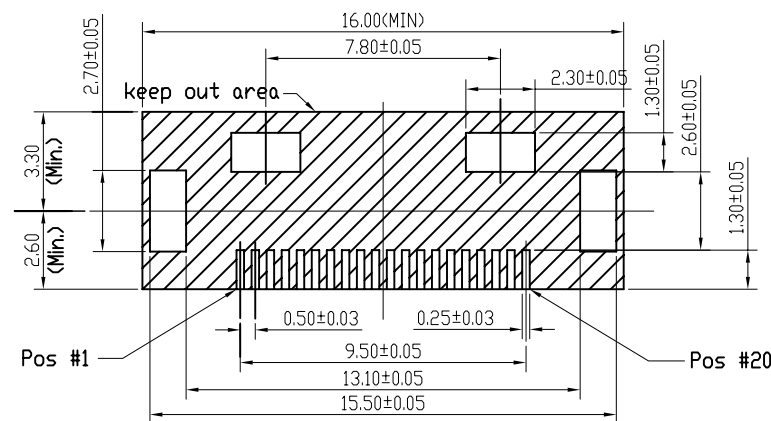
XXX	PACKING
001	50406-XXXX
W01	50406-XXXX-02
AT1	50406-XXXX-04

PACKING

- 1.TUBE
- 7.TAPE REEL WITH COVER
- 4.TAPE REEL WITH MYLAR

CONTACT PLATING

- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE



一般公差 TOLERANCES X. ±0.5 XX ±0.15 X ±0.25 XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronics Co.,Ltd.	
檢驗尺寸標示 SYMBOLS ① ② INDICATE CLASSIFICATION DIMENSION ① MARK IS CRITICAL DIM. ② MARK IS MAJOR DIM.	品名 (TITLE) 0.5mm LVDS CONN. 圖號 (DWG NO.) 50406-XXXX-XXX	製圖 (DR) 14/09/22 XIUJIN 審核 (CHKD) BRAVE 核准 (APPD) FRANK	張數 (SHEET) 2 OF 3 SIZE A4 REV J
表面處理 (FINISH)	比例 (SCALE) 4:1	單位 (UNITS) mm	



NOTES:

1. MATERIAL:

1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.

1.2 CONTACT: COPPER ALLOY

1.3 SHELL: COPPER ALLOY

2. FINISH:

2.1 CONTACT:

50u" MIN. NICKEL UNDERPLATING OVERALL.

1:1~3u" GOLD ON CONTACT FOR LEAD FREE

T:10u" GOLD ON CONTACT FOR LEAD FREE

D:30u" GOLD ON CONTACT FOR LEAD FREE

B:5u" GOLD ON CONTACT FOR LEAD FREE

C:15u" GOLD ON CONTACT FOR LEAD FREE

2.2 SHELL:

50u" MIN. NICKEL UNDERPLATING OVERALL.

50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXXX

4. PACKAGE PLS. REFER TO 50406-XXXXX-TRP/50406-XXXXX-02-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

50406-XXX X X-XXX

XXX	PACKING
001	50406-XXXXCR
W01	50406-XXXXCR-02

040:40Pin

PACKING

1.TUBE

7.TAPE REEL WITH COVER

4.TAPE REEL WITH MYLAR

CONTACT PLATING

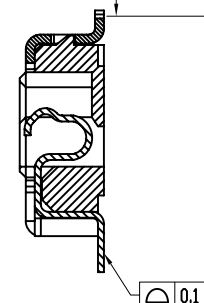
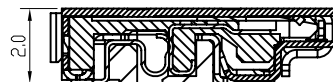
1:1~3u" GOLD ON CONTACT FOR LEAD FREE

T:10u" GOLD ON CONTACT FOR LEAD FREE

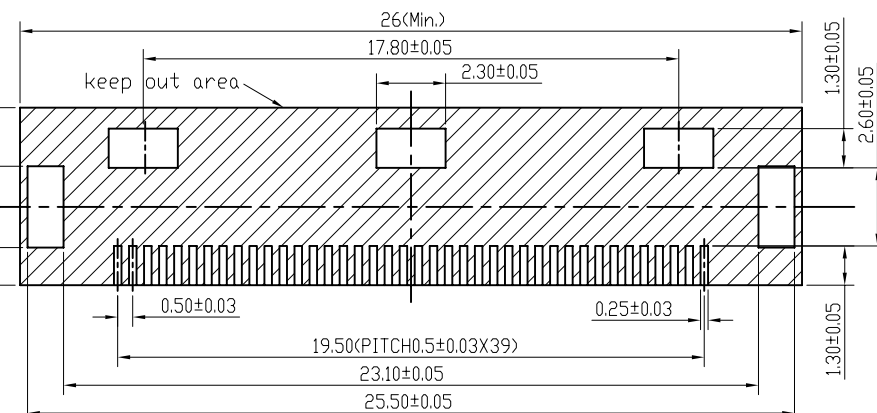
D:30u" GOLD ON CONTACT FOR LEAD FREE

B:5u" GOLD ON CONTACT FOR LEAD FREE

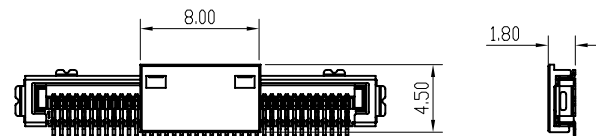
C:15u" GOLD ON CONTACT FOR LEAD FREE



SECTION B-B
SCALE 8:1



一般公差 TOLERANCES X. ±0.5 XX ±0.15 X ±0.25 XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronics Co.,Ltd.	
檢驗尺寸標示 SYMBOLS ① ② INDICATE CLASSIFICATION DIMENSION		品名 (TITLE) 0.5mm LVDS CONN.	製圖 (DR) 14/09/22 XIUJIN
① MARK IS CRITICAL DIM. ② MARK IS MAJOR DIM.		圖號 (DWG NO.) 50406-XXXXX-XXX	審核 (CHKD) BRAVE
表面處理 (FINISH)		比例 (SCALE) 4:1	核准 (APPD) FRANK
		單位 (UNITS) mm	張數 (SHEET) 3 OF 3
		尺寸 (SIZE) A4	REV J



VACUUM CLIP INSTALLATION
CONDITION 2:1